

ABSTRACT OF THE DISCLOSURE

A field emission display device is disclosed, which has a first substrate; a second substrate coated with at least a layer of phosphor; a first conducting layer locating on one surface of said first substrate; a plurality of connecting-conducting lines; an insulating layer having a plurality of holes; a second conducting layer having a plurality of holes; a plurality of cones having at least one microtip; and a sealing gel sandwiched by said second substrate and said insulating layer. The method for fabricating the field emission display device illustrated above

10 is also disclosed.